

T491V336K010AH

General Information

T491

MnO2 Tantalum

33 uF

Series

Dielectric

T491, Tantalum, MnO2 Tantalum, 33 uF, 10%, 10 VDC, SMD, MnO2, Molded, Low Profile, 700 mOhms, 7343, Height Max = 2mm

CATHODE (-) END VIEW SIDE VIEW Н T-ANODE (+) END VIEW Termination cutout at KEMET's option,

BOTTOM VIEW	Style	SMD Chip
	Description	SMD, MnO2, Molded, Low Profile
	RoHS	No
	Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
	SCIP Number	1dd2e1b8-26dd-4d52-927c-6f9d519011aa
	Termination	Solder Coated
	AEC-Q200	No
	Component Weight	286.4 mg
	Shelf Life	156 Weeks
L	MSL	1

Specifications Capacitance

Capacitance

Click here for the 3D model.

Packaging Specifications

Packaging Quantity

Packaging

Dimensions	
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	1.8mm +/-0.2mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
Α	3.6mm MIN
E	3.5mm REF
G	3.5mm REF
X	0.05mm REF

T&R, 178mm

1000

L	7.3mm +/-0.3mm	Tolerance	10%
W	4.3mm+/-0.3mm	Voltage DC	10 VDC (85C), 6.7 VDC (125C)
Н	1.8mm +/-0.2mm	Temperature Range	-55/+125°C
Т	0.13mm REF		
S	1.3mm +/-0.3mm	Rated Temperature	85°C
F	2.4mm +/-0.1mm	Dissipation Factor	6% 120Hz 25C
A	3.6mm MIN	Failure Rate	N/A
E	3.5mm REF	Resistance	0.7 Ohms (100kHz 25C)
G	3.5mm REF	Ripple Current	423 mA (rms, 100kHz 25C), 380.7 mA (rms, 85C), 169.2 mA (rms, 125C)
X	0.05mm REF	прри сантент	
		Leakage Current	3.3 uA (5min 25°C)

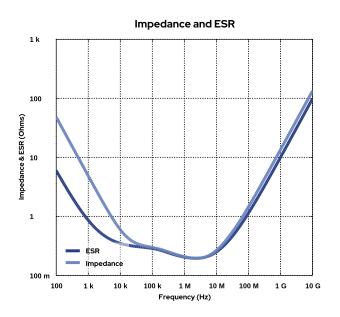
Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

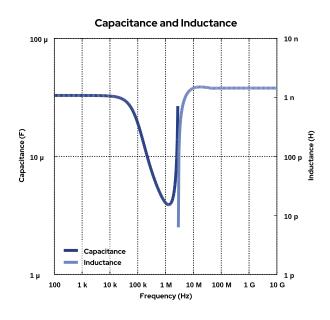


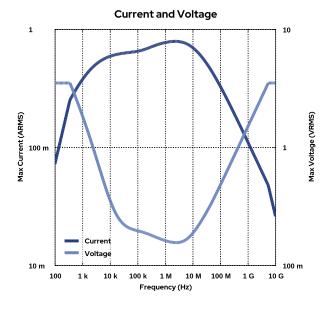
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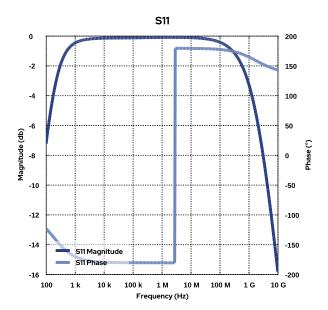
Simulations

For the complete simulation environment please visit K-SIM.





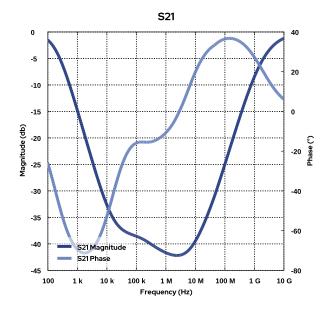






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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)